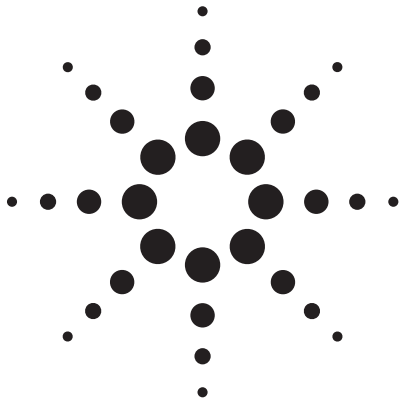


# Agilent 4N35 Phototransistor Optocoupler General Purpose Type Data Sheet



## Description

The 4N35 is an optocoupler for general purpose applications. It contains a light emitting diode optically coupled to a phototransistor. It is packaged in a 6-pin DIP package and available in wide-lead spacing option and lead bend SMD option. Response time,  $t_r$ , is typically 3  $\mu$ s and minimum CTR is 100% at input current of 10 mA.

## Ordering Information

Specify part number followed by Option Number (if desired).

4N35-XXXXE

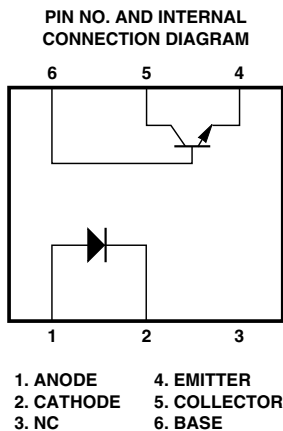
Lead Free  
Option Number

000 = No Options  
060 = IEC/EN/DIN EN 60747-5-2 Option  
W00 = 0.4" Lead Spacing Option  
300 = Lead Bend SMD Option  
500 = Tape and Reel Packaging Option

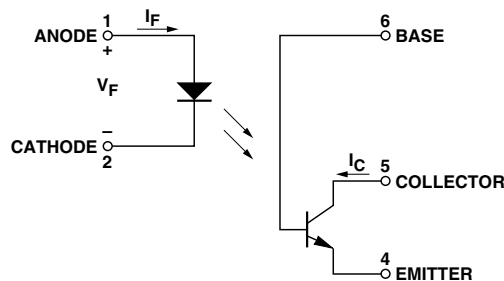
## Features

- High Current Transfer Ratio (CTR: min. 100% at  $I_F = 10$  mA,  $V_{CE} = 10$  V)
- Response time ( $t_r$ : typ., 3  $\mu$ s at  $V_{CE} = 10$  V,  $I_C = 2$  mA,  $R_L = 100 \Omega$ )
- Input-output isolation voltage ( $V_{iso} = 3550$  Vrms)
- Dual-in-line package
- UL approved
- CSA approved
- IEC/EN/DIN EN 60747-5-2 approved
- Options available:
  - Leads with 0.4" (10.16 mm) spacing (W00)
  - Leads bends for surface mounting (300)
  - Tape and reel for SMD (500)
  - IEC/EN/DIN EN 60747-5-2 approvals (060)

## Functional Diagram



## Schematic



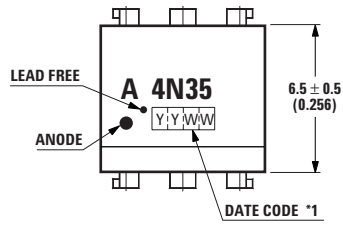
## Applications

- I/O interfaces for computers
- System appliances, measuring instruments
- Signal transmission between circuits of different potentials and impedances

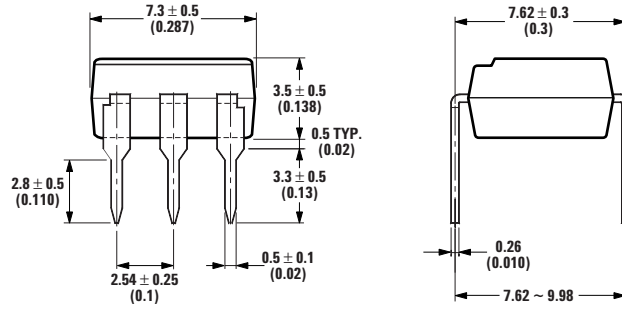
**CAUTION:** It is advised that normal static precautions be taken in handling and assembly of this component to prevent damage and/or degradation which may be induced by ESD.

## Package Outline Drawings

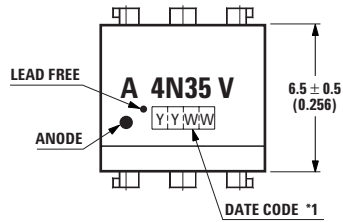
### 4N35-000E



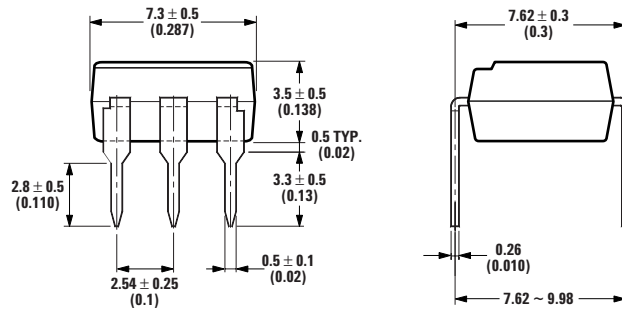
DIMENSIONS IN MILLIMETERS AND (INCHES)



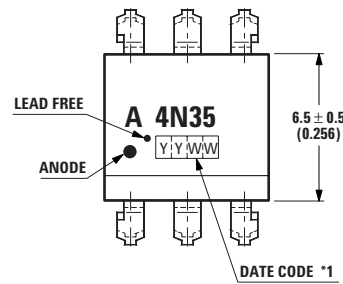
### 4N35-060E



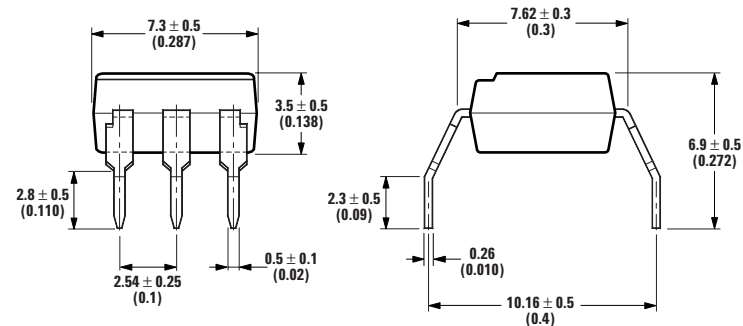
DIMENSIONS IN MILLIMETERS AND (INCHES)



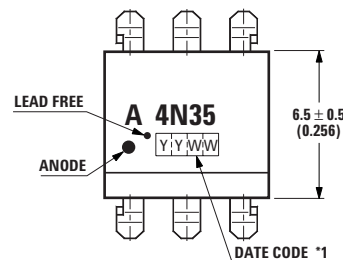
### 4N35-W00E



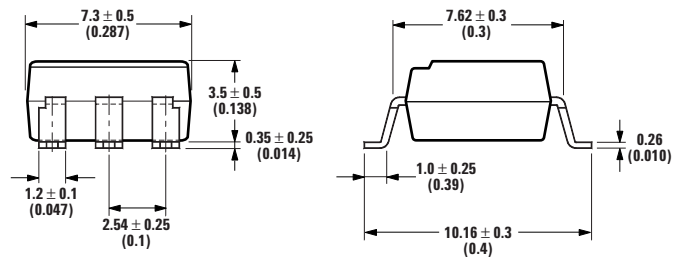
DIMENSIONS IN MILLIMETERS AND (INCHES)



### 4N35-300E

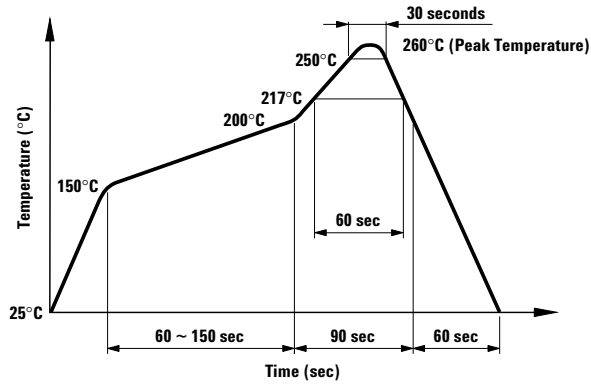


DIMENSIONS IN MILLIMETERS AND (INCHES)



**Solder Reflow Temperature Profile**

- 1) One-time soldering reflow is recommended within the condition of temperature and time profile shown at right.
- 2) When using another soldering method such as infrared ray lamp, the temperature may rise partially in the mold of the device. Keep the temperature on the package of the device within the condition of (1) above.



**Absolute Maximum Ratings**

Storage Temperature, $T_S$	-55°C to +150°C
Operating Temperature, $T_A$	-55°C to +100°C
Lead Solder Temperature, max. (1.6 mm below seating plane)	260°C for 10 s
Average Forward Current, $I_F$	60 mA
Reverse Input Voltage, $V_R$	6 V
Input Power Dissipation, $P_I$	100 mW
Collector Current, $I_C$	100 mA
Collector-Emitter Voltage, $V_{CE0}$	30 V
Emitter-Collector Voltage, $V_{EC0}$	7 V
Collector-Base Voltage, $V_{CB0}$	70 V
Collector Power Dissipation	300 mW
Total Power Dissipation	350 mW
Isolation Voltage, $V_{ISO}$ (AC for 1 minute, R.H. = 40 ~ 60%)	3550 Vrms

**Electrical Specifications (T<sub>A</sub> = 25°C)**

Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
Forward Voltage	V <sub>F</sub>	–	1.2	1.5	V	I <sub>F</sub> = 10 mA
Reverse Current	I <sub>R</sub>	–	–	10	μA	V <sub>R</sub> = 4 V
Terminal Capacitance	C <sub>t</sub>	–	50	–	pF	V = 0, f = 1 KHz
Collector Dark Current	I <sub>CEO</sub>	–	–	50	nA	V <sub>CE</sub> = 10 V, I <sub>F</sub> = 0, T <sub>A</sub> = 25°C
		–	–	500	μA	V <sub>CE</sub> = 30 V, I <sub>F</sub> = 0, T <sub>A</sub> = 100°C
Collector-Emitter Breakdown Voltage	BV <sub>CEO</sub>	30	–	–	V	I <sub>C</sub> = 0.1 mA, I <sub>F</sub> = 0
Emitter-Collector Breakdown Voltage	BV <sub>ECO</sub>	7	–	–	V	I <sub>E</sub> = 10 μA, I <sub>F</sub> = 0
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	70	–	–	V	I <sub>C</sub> = 0.1 mA, I <sub>F</sub> = 0
Collector Current	I <sub>C</sub>	10	–	–	mA	I <sub>F</sub> = 10 mA
*Current Transfer Ratio	CTR	100	–	–	%	V <sub>CE</sub> = 10 V
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	–	–	0.3	V	I <sub>F</sub> = 50 mA, I <sub>C</sub> = 2 mA
Response Time (Rise)	t <sub>r</sub>	–	3	10	μs	V <sub>CC</sub> = 10 V, I <sub>C</sub> = 2 mA
Response Time (Fall)	t <sub>f</sub>	–	3	10	μs	R <sub>L</sub> = 100 Ω
Isolation Resistance	R <sub>iso</sub>	5 x 10 <sup>10</sup>	1 x 10 <sup>11</sup>	–	Ω	DC 500 V 40 ~ 60% R.H.
Floating Capacitance	C <sub>f</sub>	–	1	2.5	pF	V = 0, f = 1 MHz

\* CTR =  $\frac{I_C}{I_F} \times 100\%$

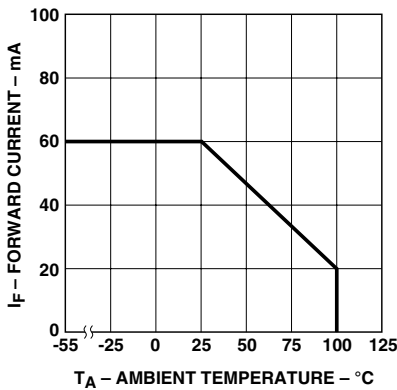


Figure 1. Forward current vs. temperature.

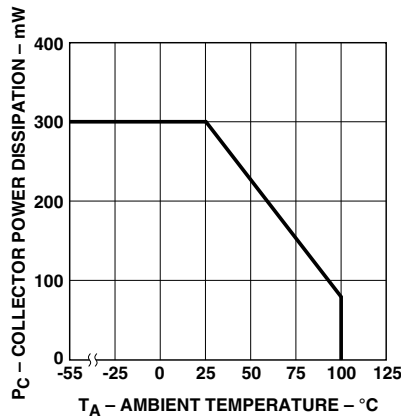


Figure 2. Collector power dissipation vs. temperature.

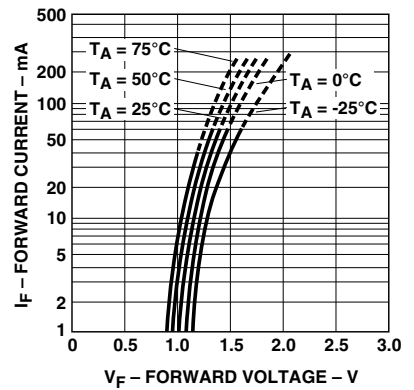


Figure 3. Forward current vs. forward voltage.

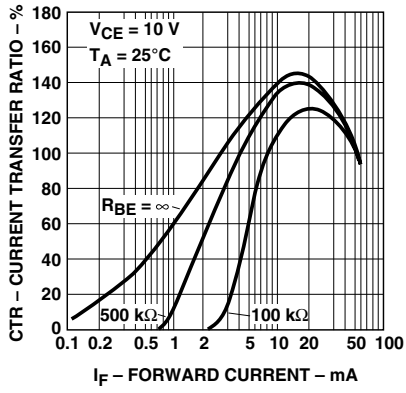


Figure 4. Current transfer ratio vs. forward current.

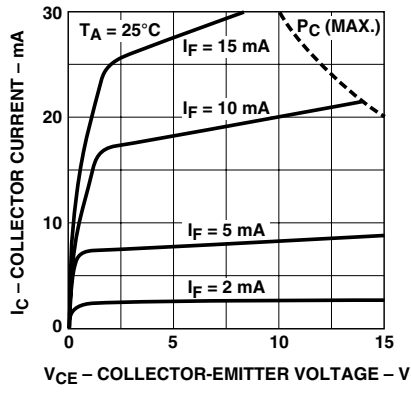


Figure 5. Collector current vs. collector-emitter voltage.

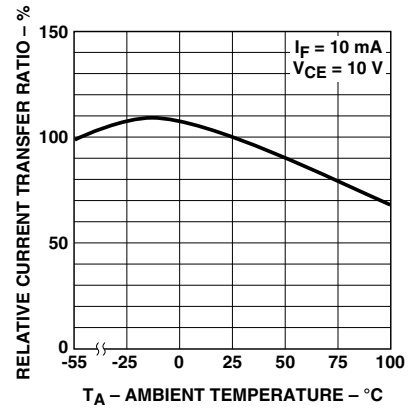


Figure 6. Relative current transfer ratio vs. temperature.

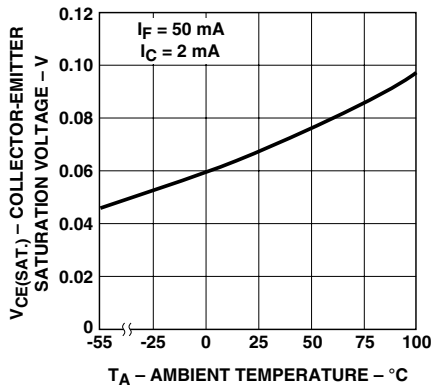


Figure 7. Collector-emitter saturation voltage vs. temperature.

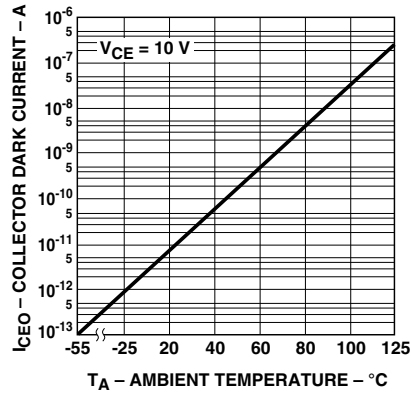


Figure 8. Collector dark current vs. temperature.

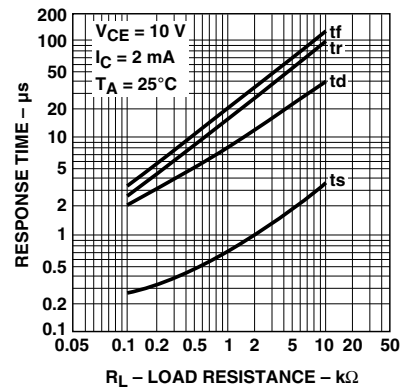


Figure 9. Response time vs. load resistance.

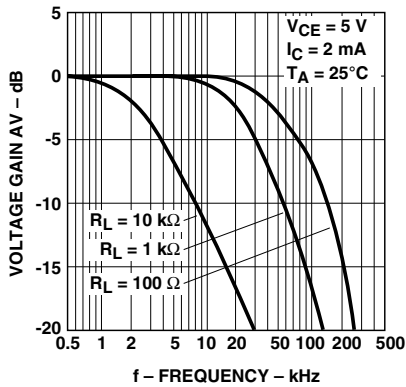


Figure 10. Frequency response.

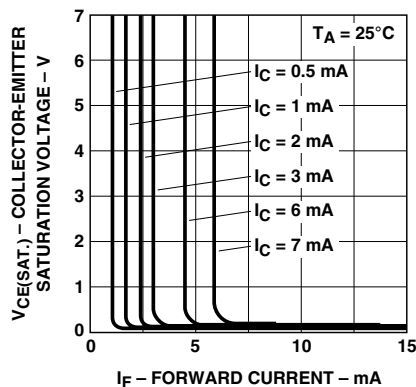
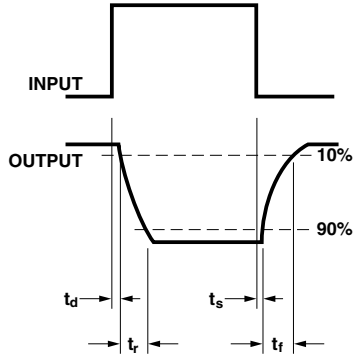
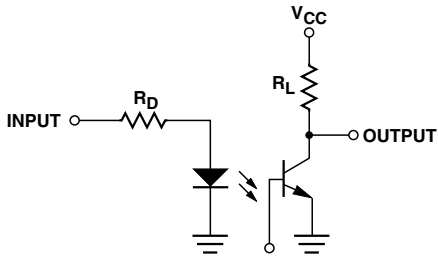
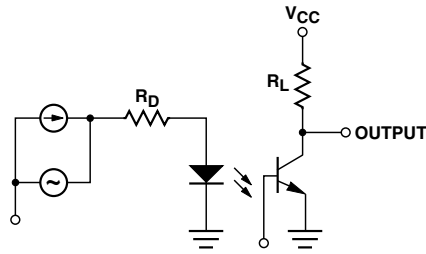


Figure 11. Collector-emitter saturation voltage vs. forward current.

### Test Circuit for Response Time



### Test Circuit for Frequency Response



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Data subject to change.

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